

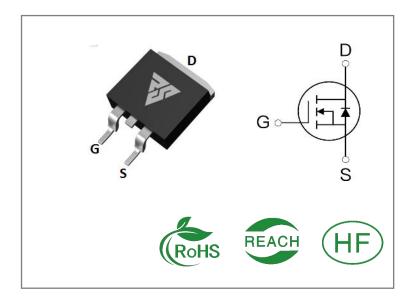
ID	R _{DS} (ON)(Typ)	VDSS
150A	2.8 m Ω	85V

Applications:

- Load Switch
- PWM Applications
- Power Managment

Features:

- Fast switching speed
- 100% avalanche tested
- Improved dv/dt capability



Ordering Information

Part Number	Package	Marking	Packing	Qty.
RS85N150S	T0-263	RS85N150S	Tape&reel	800 PCS

Absolute Maximun Ratings Tc= 25℃ unless otherwise specified

Symbol	Parameter	RS85N150S	Units
VDSS	Drain-to-Source Voltage	85	V
ID	Continuous Drain Current TC=25℃	150	
ID	Continuous Drain Current TC=100℃	140	Α
IDM	Pulsed Drain Current	600	
PD	Power Dissipation	312	W
VGS	Gate- to- Source Voltage	±20	٧
EAS	Single Pulse Avalanche Engergy L = 0.5mH,IS = 55A, RG = 25 Ω , Tj = 25 $^{\circ}$ C	756	mJ
	Maximum Temperature for Soldering		
TL TPKG	Leads at 0.063in(1.6mm)from Case for 10 seconds Package Body for 10 seconds	300 260	${\mathbb C}$
TJ and TSTG	Operating Junction and Storage Temperature Range	-55 to 150	

^{*} Drain Current Limited by Maximum Junction Temperature

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" Table may cause permanent damage to the device.



Thermal Resistance

Symbol	Parameter	RS85N150S	Units	Test Conditions
RθJC	Junction-to-Case	0.4	°C/W	Drain lead soldered to water cooled heatsink, PD adjusted for a peak junction temperature of + 1 5 0 $^{\circ}{\rm C}$
RθJA	Junction-to- Ambient	52		1 cubic foot chamber,free air.

OFF Characteristics TJ= 25 ^oC unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BVDSS	Drain- to- source Breakdown Voltage				V	VGS=0V,ID=250μ A
IDSS	Drain- to- Source Leakage Current			1	μΑ	VDS=80V,VGS=0 V
IGSS	Gate- to- Source Forward Leakage			100	- A	VGS=20V ,VDS=0 V
1033	Gate- to- Source Reverse Leakage			-100	nA	VGS=-20V ,VDS= 0V

ON Characteristics TJ=25°C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
RDS(on)	Static Drain- to- Source On- Resistance		2.7	3.4	mΩ	VGS=10V,ID=60A
VGS(TH	Gate Threshold Voltage	2.0		4.0	V	VGS=VDS,ID=25 0μA

Resistive Switching Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
td(ON)	Turn- on Delay Time		37			VDC 40V
trise	Rise Time		63			VDS=43V ID=60A
td(OFF)	Turn- OFF Delay Time		78		nS	RG=4.7Ω VGS=10V
tfall	Fall Time		41			VG3=10V



Dynamic Characteristics Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Ciss	Input Capacitance		7447			VGS= 0V
Coss	Output Capacitance		1075		рF	VDS=43V
Crss	Reverse Transfer Capacitance		43			f=100KHz
Qg	Total Gate Charge		130			VDS= 68V
Qgs	Gate- to- Source Charge		40		nC	ID=60A
Qgd	Gate-to-Drain(" Miller") Charge		39			VGS=10V

Source-Drain Diode Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
IS	Continuous Source Current			150	Α	Integral pn- diode
ISM	Maximum Pulsed Current			600	Α	in MOSFET
VSD	Diode Forward Voltage			1.4	V	IS=60A,VGS=0V
trr	Reverse Recovery Time		56		nS	VGS=0V
Qrr	Reverse Recovery Charge		84		nC	IS=60A di/dt=100A/μs

Notes:

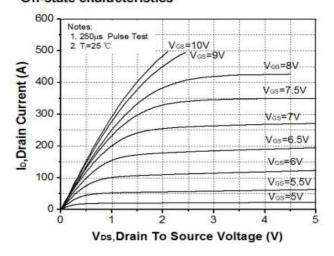
^{* 1.} Repetitive rating, pulse width limited by maximum junction temperature.

^{* 2.} Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 1.5%

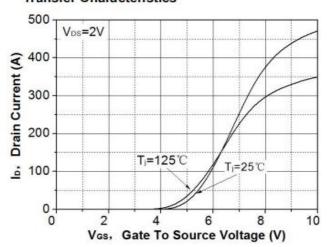


Typical Feature Curve

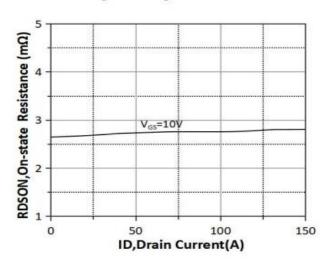
On-state characteristics



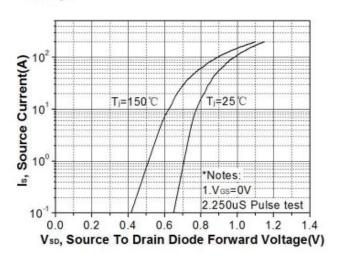
Transfer Characteristics



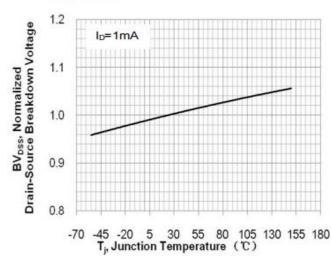
On-resistance variation vs.drain current and gate voltage



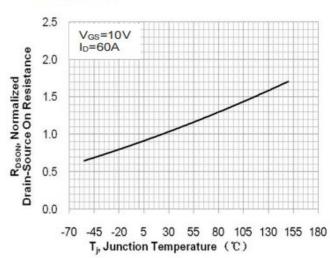
On-state current vs. diode forward voltage



Breakdown voltage variation vs. junction temperature

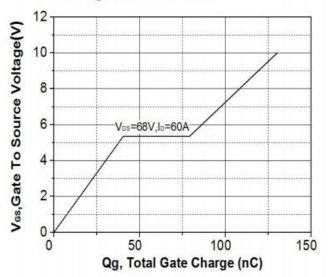


On-resistance variation vs. junction temperature

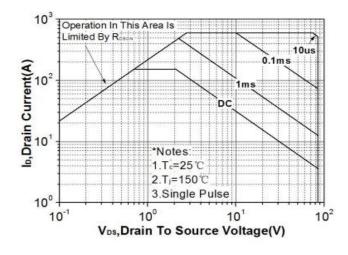




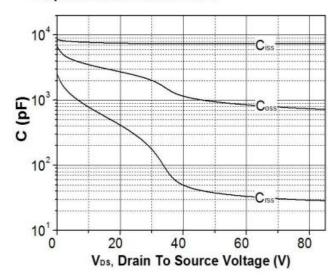
Gate charge characteristics



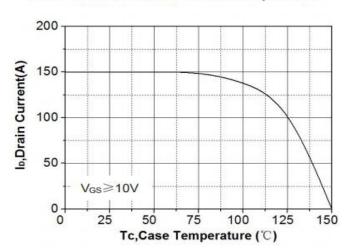
Maximum safe operating area



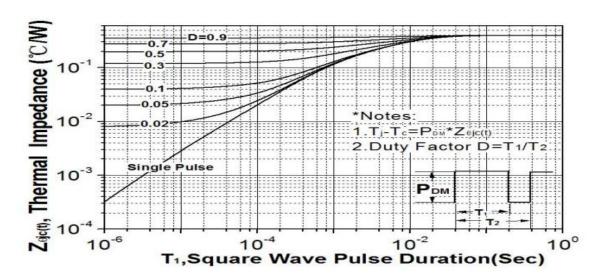
Capacitance characteristics



Maximum drain current vs. case temperature



Transient thermal response curve





Test ircuits and Waveforms

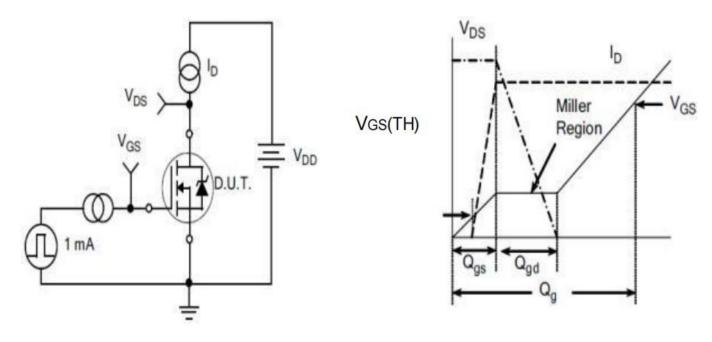


Figure A.
Gate Charge Test Circuit

V_{DS} V_{DS}

Figure C.
Resistive Switching Test Circuit

Figure D.
Resistive Switching Waveforms

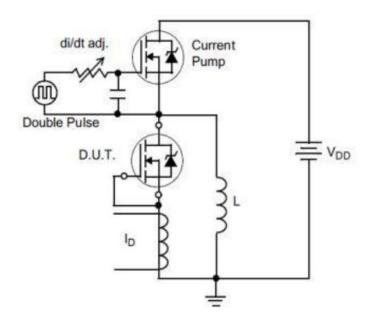
Figure B.

Gate Charge Waveform

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Test ircuits and Waveforms



 $\frac{di/dt = 100A/\mu A}{Q_{rr}}$

Figure E.Diode Reverse Recovery Test Circuit

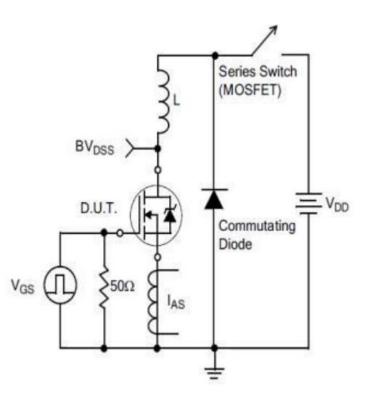


Figure G.Unclamped Inductive Switching Test Circuit

Figure F.Diode Reverse Recovery Waveform

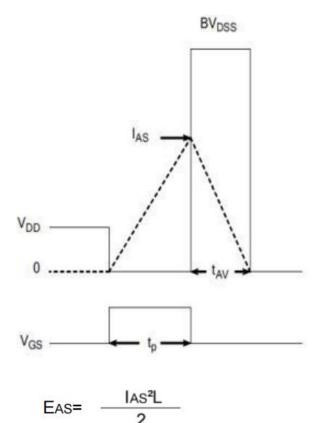
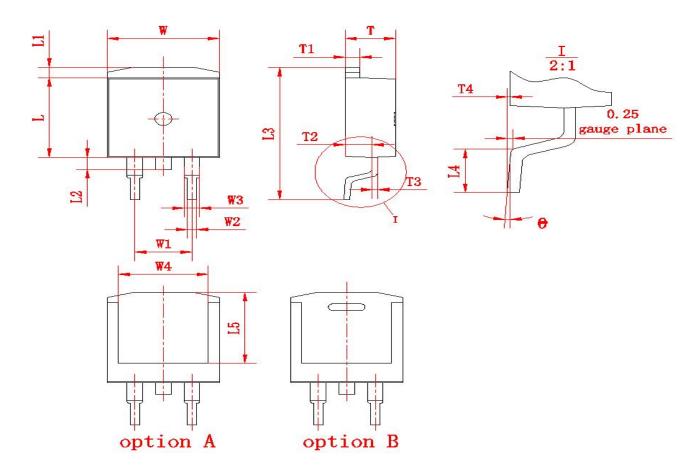


Figure H.Unclamped Inductive Switching Waveforms

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Package outline drawing(TO-263 Unit: mm)



(单位: mm)

符号	尺寸		<i>የተ</i> 🗆	尺寸		かロ	尺寸	
	Min	Max	符号	Min	Max	符号	Min	Max
W	9. 80	10. 20	L1	1.00	1.40	T1	1. 20	1.40
W1	(5. 08)		L2	1. 20	1.60	T2	2. 20	2. 60
W2	0. 70	0.95	L3	15. 00	15. 60	Т3	0. 45	0. 65
W 3	1.17	1. 62	L4	2. 20	2. 80	T4	0	0. 25
W 4	(8)	. 0)	L5	(8. 2)		θ	0°	8°
L	9.00	9. 40	T	4. 30	4. 70			



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DMN1017UCP3-7 EFC2J004NUZTDG P85W28HP2F-7071 DMN1053UCP4-7 NTE2384 DMC2700UDMQ-7 DMN2080UCB4-7
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STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 IPS60R360PFD7SAKMA1
DMN2990UFB-7B SSM3K35CT,L3F IPLK60R1K0PFD7ATMA1 2N7002W-G MCAC30N06Y-TP IPWS65R035CFD7AXKSA1
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PJMF280N60E1 T0 00201 PJMF600N65E1 T0 00201 PJMF900N65E1 T0 00201